SF81 THRU SF88

Glass Passivated Super Fast Rectifier Reverse Voltage - 50 to 600 V Forward Current - 8 A

Features

- · Low forward voltage drop
- · Low reverse leakage current
- · Superfast switching time for high efficiency
- · High current capability
- · High surge current capability

Mechanical Data

· Case: Molded plastic, TO-220A

• Epoxy: UL 94V-0 rate flame retardant

• Terminals: leads solderable per MIL-STD-202

method 208 guaranteed

Polarity: As markedMounting Position: Any

TO-220A .187 (4.7) .153 (3.9) .413 (10.5) .146 (3.7) .053 (1.3) .047 (1.2) 270 (6.9) 230 (5.8) 610 (15.5 .04MAX. (1.0)▼ .583 (14.8) (1.3).022 (0.56) .102 (2.6) 014 (0.36) PIN 1 PIN 2 O→ Case Positive

Dimensions in inches and (millimeters)

Absolute Maximum Ratings and Characteristics

Ratings at 25 $^{\circ}$ C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	SF81	SF82	SF83	SF84	SF85	SF86	SF87	SF88	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	500	600	V
Maximum RMS Voltage	V_{RMS}	35	70	105	140	210	280	350	420	٧
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	500	600	V
Maximum Average Forward Rectified Current at T _C = 100 °C	I _(AV)	8								А
Peak Forward Surge Current 8.3 ms Single half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	125								А
Maximum Forward Voltage at 8 A and 25 °C	V _F	0.95 1.3 1.7						V		
Maximum Reverse Current at $T_A = 25$ °C at Rated DC Blocking Voltage $T_A = 125$ °C	I _R	10 500								μΑ
Typical Junction Capacitance 1)	С		80				60			pF
Maximum Reverse Recovery Time 2)	t _{rr}	35 50						ns		
Typical Thermal Resistance 3)	Rejc	2.2							°C/W	
Operating and Storage Temperature Range	T_j , T_{stg}	- 55 to + 150								°C

¹⁾ Measured at 1 MHz and applied reverse voltage of 4 V.

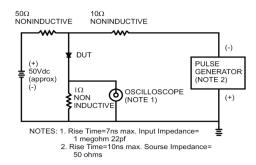


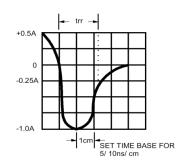
Reverse recovery test conditions: $I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{RR} = 0.25 \text{ A}$

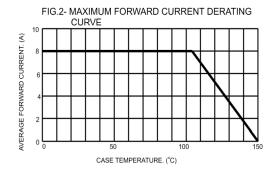
³⁾ Thermal resistance from Junction to case mounted on heatsink.

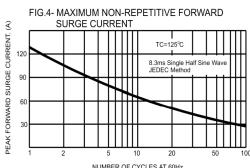
RATINGS AND CHARACTERISTIC CURVES

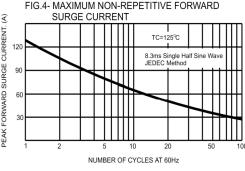
FIG.1- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM











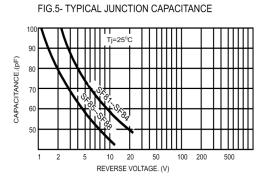


FIG.3- TYPICAL REVERSE CHARACTERISTICS

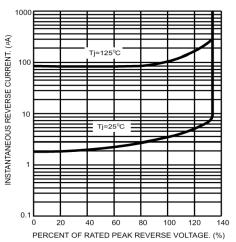


FIG.6- TYPICAL FORWARD CHARACTERISTICS

